



PCB LAYOUT
(BOTTOM VIEW)

REQUIREMENTS
 CONTACT RESISTANCE:30mΩmax.(INITIAL)
 INSULATION RESISTANCE:100MΩmin.AT 500V DC.
 WITHSTANDING VOLTAGE:500V AC FOR ONE MINUTE
 SOLDERING HEAT TEST:260±5°C FOR 5±1 SECONDS
 INSERTION FORCE:0.5-4.5KG
 EXTRACTION FORCE:0.4-3.5 KG
 LIFE TIME:5000 CYCLES min

NO	NAME	MATERIAL	FINISH	REMARK	Q'TY
1	HOUSING	P.B.T	BLACK		1
2	CONTACT	PHOS.BRONZE	GOLD-TIN PLATED	Ni:1~1.5u TIN:Su Gold:1~3u	6
3	GROUND	BRASS	TIN PLATED	TIN:3~5u	1
4	BACK COVER	P.B.T	BLACK		1

尚益科技有限公司 JMSCONN TECHNOLOGY CO., LED.					
PROJ		SCALE : F DO NOT SCALE DWG	MOLD NO 30001-6-02		
APP			MODEL	FILE NO	REV. X1
CHK	CCJ	90.06.20	UNIT MM	SHT 1 OF 1	SIZE A4
DGN	WU	90.06.20			
DRW	SHIEH	90.06.20			